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LM25011 3.3V 1A DC/DC Converter
Project: Designed for: Public Release

Assembly Variant: Variant name is not interpreted until output

VIN1 3.3V@1A
BST 10
PGD 8
CSG 7
GND 5
FB 6
RT2

3.3UH L1

4.7Uf C1
34.8K R1
0.1Uf C2

4.7Uf C4

0.022Uf C3

0.1Uf C5

8.25K R3
2.61K R4

D1

GND

1.00 R5
820PF C6

11/11/2009
NSC1035.SchDoc
Sheet Title:
Size: Schematic:
Mod. Date:
File:
Rev:
Sheet: of
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